



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Board Level Cooling – High Power Extruded 5320



BOARD LEVEL COOLING – High Power Extruded 5320

High Power Extruded 5320 is a series of dual radial board level heat sinks designed to cool TO-220 and TO-220-single gauge devices. Representative image only.

ORDERING INFORMATION

Part Number	Device Type
532602B00000G	TO-220
532602B02500G	TO-220, TO-220-single gauge
532702B02500G	TO-220, TO-220-single gauge
532802B00000G	TO-220, TO-220-single gauge
532802B02500G	TO-220, TO-220-single gauge



HEAT SINK DETAILS

Property	Details
Material	Aluminum
Finish	Black Anodize
Device Attachment Options	Requires Mounting Kit
Thermal Interface Material	-

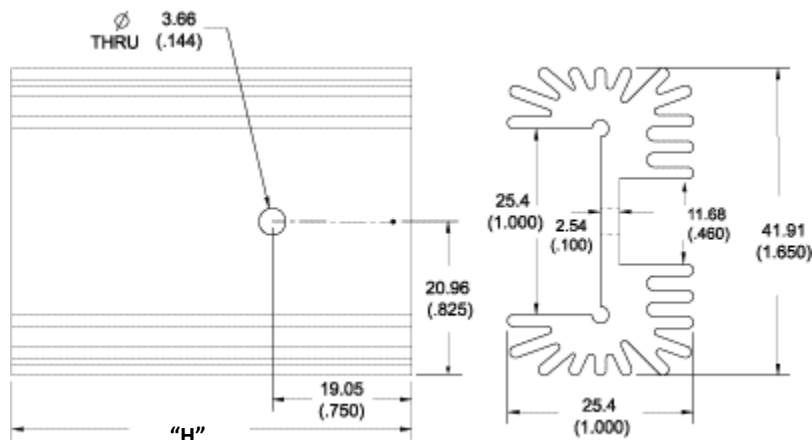
Property	Details
Heat Sink Width (mm)	41.91
Heat Sink Length (mm)	25.40
Heat Sink Height (mm)	See "H" Dim below
Heat Sink Mounting Direction	Vertical

MECHANICAL & PERFORMANCE

Drawing dimensions are shown in mm, (in)

Part Number	"H" Dim	"X" Dim	"Y" Dim	"Z" Dim
532602B00000G	38.10	12.70 (0.50)	0.79 (0.031)	2.67 (0.105)
532602B02500G	38.10	12.70 (0.50)	-	2.67 (0.105)
532702B02500G	50.80	12.65 (0.498)	-	2.67 (0.105)
532802B00000G	63.50	12.70 (0.50)	0.79 (0.031)	2.67 (0.105)
532802B02500G	63.50	12.70 (0.50)	-	2.67 (0.105)

Part Numbers: 532602B00000G and 532802B00000G



Board Level Cooling – High Power Extruded 5320

Part Numbers: 532602B02500G,
532702B02500G, 532802B02500G

